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MOSFET - SiC Power, Single N-Channel 900 V, 60 mΩ, 46 A

NVH4L060N090SC1

Features

- Typ. $R_{DS(on)} = 60 \text{ m}\Omega$
- Ultra Low Gate Charge (typ. Q_{G(tot)} = 87 nC)
- Low Effective Output Capacitance (typ. Coss = 113 pF)
- 100% UIL Tested
- Qualified According to AEC-Q101
- These Devices are RoHS Compliant

Typical Applications

- Automotive On Board Charger
- Automotive DC/DC converter for EV/HEV

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	900	V
Gate-to-Source Voltage	Gate-to-Source Voltage			+19/-10	V
Recommended Opera- tion Values of Gate-to- Source Voltage	T _C < 175°C		V _{GSop}	-5/+15	V
Continuous Drain Current $R_{\theta JC}$	Steady $T_{C} = 25^{\circ}C$		Ι _D	46	A
Power Dissipation $R_{\theta JC}$	Oldie	State TC = 25 C	PD	221	W
Continuous Drain Current $R_{\theta JC}$	Steady	eady tate T _C = 100°C	۱ _D	32	A
Power Dissipation $R_{\theta JC}$	Sidle		PD	110	W
Pulsed Drain Current (Note 2)	T _A	= 25°C	I _{DM}	211	A
Single Pulse Surge Drain Current Capability (Note 3)	$\label{eq:TA} \begin{split} T_{A} &= 25^{\circ}C, t_{p} = 10 \; \mu \text{s}, \\ R_{G} &= 4.7 \; \Omega \end{split}$		I _{DSC}	320	A
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			I _S	22	А
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 18 \text{ A}, L = 1 \text{ mH}$) (Note 4)			E _{AS}	162	mJ

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Note 1)	$R_{\theta JC}$	0.68	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

- 2. Repetitive rating, limited by max junction temperature.
- 3. Peak current might be limited by transconductance.

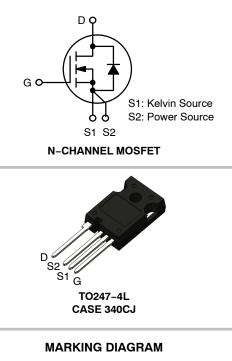
4. E_{AS} of 162 mJ is based on starting T_J = 25°C; L = 1 mH, I_{AS} = 18 A, V_{DD} = 100 V, V_{GS} = 15 V.

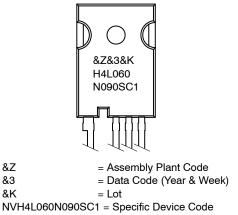


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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
900 V	84 mΩ @ 15 V	46 A





ORDERING INFORMATION

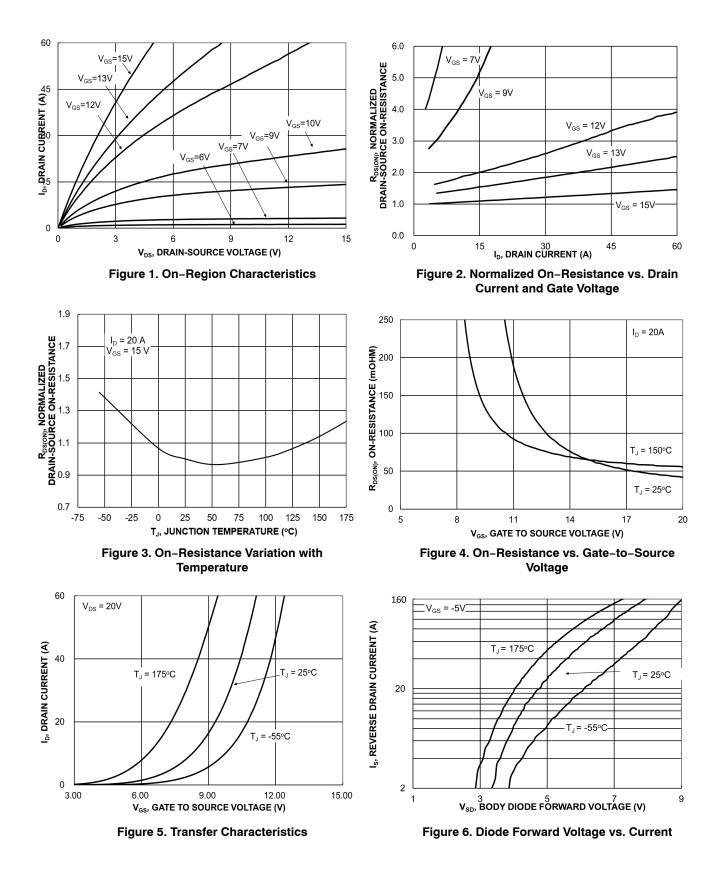
See detailed ordering and shipping information on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS

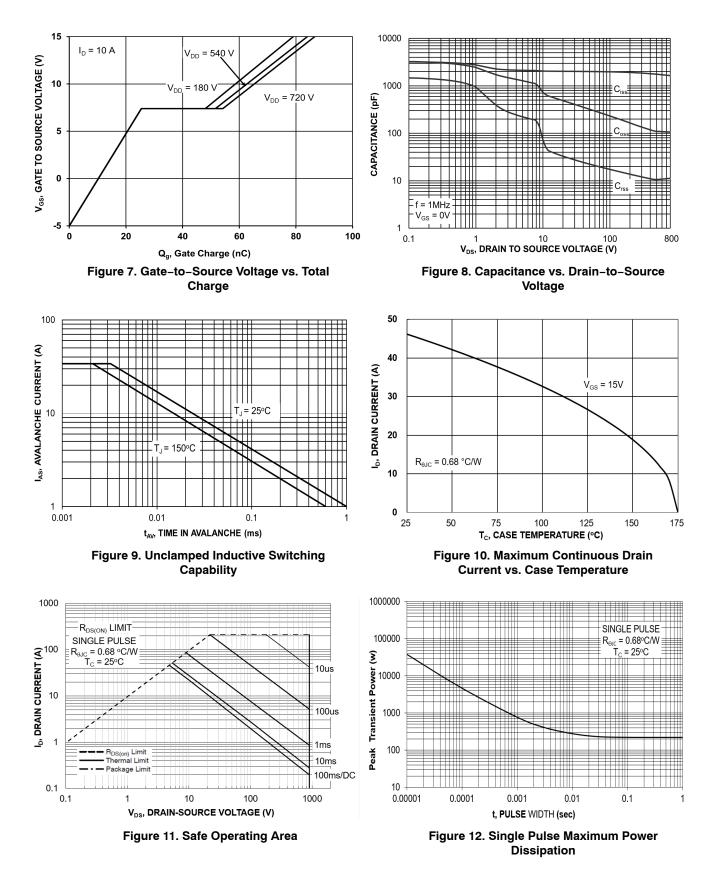
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
OFF CHARACTERISTICS	•	•		1		1	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 1 mA	900			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 1$ mA, referenced to 25°C		574		mV/°C	
Zero Gate Voltage Drain Current	I _{DSS}	V_{GS} = 0 V, V_{DS} = 900 V, T_{J} = 25°C			100	μΑ	
		V_{GS} = 0 V, V_{DS} = 900 V, T_{J} = 175°C			250		
Gate-to-Source Leakage Current	I _{GSS}	V_{GS} = +19/-10 V, V_{DS} = 0 V			±1	μΑ	
ON CHARACTERISTICS	•	· · · ·					
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_D = 5 \text{ mA}$	1.8	2.7	4.3	V	
Recommended Gate Voltage	V _{GOP}		-5		+15	V	
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 15 V, I _D = 20 A, T _J = 25°C		60	84	mΩ	
		V_{GS} = 15 V, I _D = 20 A, T _J = 175°C		76			
Forward Transconductance	9 _{FS}	V _{DS} = 20 V, I _D = 20 A		17		S	
CHARGES, CAPACITANCES & GATE	RESISTANCE	•		1		1	
Input Capacitance	C _{ISS}			1770		pF	
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 450 V		113		-	
Reverse Transfer Capacitance	C _{RSS}			11			
Total Gate Charge	Q _{G(tot)}			87		nC	
Threshold Gate Charge	Q _{G(th)}			17		_	
Gate-to-Source Charge	Q _{GS}	$V_{GS} = -5/15$ V, $V_{DS} = 720$ V, $I_D = 10$ A		27		-	
Gate-to-Drain Charge	Q _{GD}			26			
Gate Resistance	R _G	f = 1 MHz		3.0		Ω	
SWITCHING CHARACTERISTICS		· · · · · ·		1		1	
Turn-On Delay Time	t _{d(on)}			17	31	ns	
Rise Time	t _r			15	27	_	
Turn–Off Delay Time	t _{d(off)}			29	47	1	
Fall Time	t _f	V_{GS} = -5/15 V, V_{DS} = 720 V, I _D = 20 A, R _G = 2.5 Ω,		11	20		
Turn-On Switching Loss	E _{ON}	Inductive Load		183		μJ	
Turn-Off Switching Loss	E _{OFF}			52			
Total Switching Loss	E _{TOT}			235		_	
DRAIN-SOURCE DIODE CHARACTER	RISTICS	•		1		1	
Continuous Drain-to-Source Diode Forward Current	I _{SD}	V_{GS} = -5 V, T _J = 25°C			22	A	
Pulsed Drain-to-Source Diode For- ward Current (Note 2)	I _{SDM}	V_{GS} = -5 V, T _J = 25°C			184	A	
Forward Diode Voltage	V _{SD}	V_{GS} = -5 V, I_{SD} = 10 A, T_{J} = 25°C		3.9		V	
Reverse Recovery Time	t _{RR}			18		ns	
Reverse Recovery Charge	Q _{RR}	1		84		nC	
Reverse Recovery Energy	E _{REC}	V _{GS} = -5/15 V, I _{SD} = 30 A,		1.0		μJ	
Peak Reverse Recovery Current	I _{RRM}	$dI_S/dt = 1000 \text{ A}/\mu \text{s}, V_{DS} = 720 \text{ V}$		9.0		А	
Charge Time	ta	1		10		ns	
Discharge Time	t _b	1 1		8.0		ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

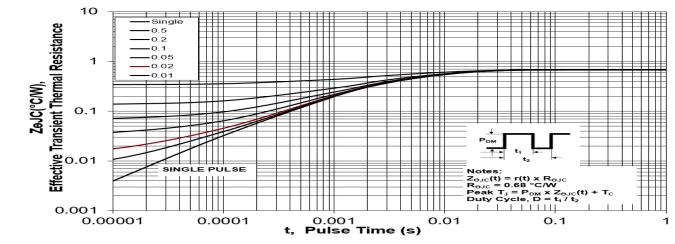


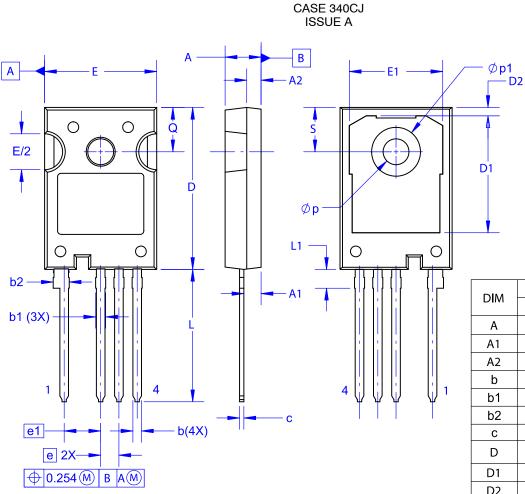
Figure 13. Junction-to-Ambient Thermal Response

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NVH4L060N090SC1	H4L060N090SC1	TO247-4L	Tube	N/A	N/A	30 Units

PACKAGE DIMENSIONS

TO-247-4LD



NOTES:

A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
B. DIMENSIONS ARE EXCLUSIVE OF BURRS,MOLD FLASH,AND TIE BAR EXTRUSIONS.
C. ALL DIMENSIONS ARE IN MILLIMETERS.
D. DRAWING CONFORMS TO ASME Y14.5-2009.

DIM	MILLIMETERS				
DIM	MIN	NOM	MAX		
А	4.80	5.00	5.20		
A1	2.10	2.40	2.70		
A2	1.80	2.00	2.20		
b	1.07	1.20	1.33		
b1	1.20	1.40	1.60		
b2	2.02	2.22	2.42		
С	0.50	0.60	0.70		
D	22.34	22.54	22.74		
D1	16.00	16.25	16.50		
D2	0.97	1.17	1.37		
е	2	2.54 BSC			
e1	Ę	5.08 BSC	2		
Е	15.40	15.60	15.80		
E1	12.80	13.00	13.20		
E/2	4.80	5.00	5.20		
L	18.22	18.42	18.62		
L1	2.42	2.62	2.82		
р	3.40	3.60	3.80		
p1	6.60	6.80	7.00		
Q	5.97	6.17	6.37		
S	5.97	6.17	6.37		

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PUBLICATION ORDERING INFORMATION

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